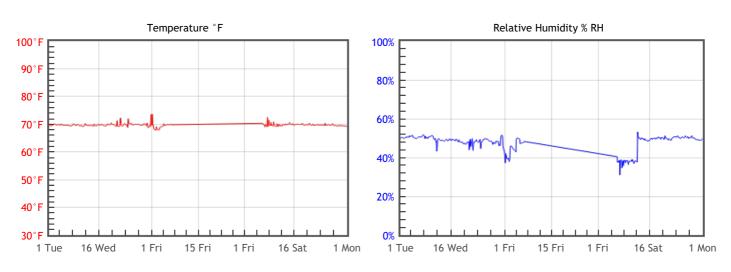
## **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments	
Natural Aging Chemical decay of organic materials	RISK TWPI = 42	Accelerated rate of chemical decay in all organic materials due to the cumulative effects of temperature and humidity, with especially high risk for fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics.	
Mechanical Damage Physical damage to hygroscopic materials	OK % DC = 0.52 % EMC min = 7.2 % EMC max = 9.1	Generally OK, but sensitive or fast responding hygroscopic materials such as paintings, rare books, vellum manuscripts or musical instruments will be at elevated risk of physical damage due to fluctuations of humidity.	
Mold Risk Mold growth in area or on collection objects	GOOD MRF = 0	Minimal risk of mold growth.	
Metal Corrosion Corrosion of metal components or objects	ОК % EMC max = 9.1	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.	

## Graphs



## Statistics

Temperature		Relative Humidity		Dew Point	
T°F Mean	69.7	%RH Mean	48	DP°F Mean	48.9
T°F Median	69.7	%RH Median	49	DP°F Median	49.8
T°F Stdev	0.8	%RH Stdev	4	DP°F Stdev	2.4
T°F Min	67.8	%RH Min	31	DP°F Min	41.9
T°F Max	75.3	%RH Max	53	DP°F Max	52.4

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